

# BLUE LINE™ Hyper ARGUS® LED

## Hyper-Bright, 3 mm (T1) LED, Non Diffused

LB K376



### Besondere Merkmale

- **Gehäusetypp:** nicht eingefärbtes, klares 3 mm (T1) Gehäuse mit spezieller Linse
- **Besonderheit des Bauteils:** mit Einsatz eines äußeren Reflektors zur Hinterleuchtung von Lichtfeldern und LCD-Anzeigen; Lötspieße mit Aufsetzebene
- **Wellenlänge:** 465 nm
- **Abstrahlwinkel:** angepasst an Einsatz mit äußerem Reflektor, siehe Diagramm
- **Technologie:** GaN
- **Gruppierungsparameter:** Lichtstrom
- **Lötmethode:** Wellenlöten (TTW)
- **Verpackung:** Schüttgut, gegurtet lieferbar
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

### Anwendungen

- optischer Indikator
- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung, u.ä.)
- Einkopplung in Lichtleiter

### Features

- **package:** colorless, clear 3 mm (T1) package with specially shaped lens
- **feature of the device:** for backlighting and LCDs with use of a reflector; solder leads with stand-off
- **wavelength:** 465 nm
- **viewing angle:** matched to use with external reflector, see diagram
- **technology:** GaN
- **grouping parameter:** luminous flux
- **soldering methods:** TTW soldering
- **packing:** bulk, available taped on reel
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

### Applications

- optical indicators
- backlighting (LCD, switches, keys, displays, illuminated advertising, general lighting)
- interior automotive lighting (e.g. dashboard backlighting, etc.)
- coupling into light guides

Typ	Emissions- farbe	Farbe der Lichtaustritts- fläche	Lichtstrom	Bestellnummer
Type	Color of Emission	Color of the Light Emitting Area	Luminous Flux $I_F = 10 \text{ mA}$ $\Phi_V \text{ (mlm)}$	Ordering Code
LB K376	blue	colorless clear		Q62703-Q4069
LB K376-L1			11.2 ... 14.0	
LB K376-L2			14.0 ... 18.0	
LB K376-M1			18.0 ... 22.4	
LB K376-M2			22.4 ... 28.0	
LB K376-N1			28.0 ... 35.5	

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11 \%$ .

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe oder mindestens zwei Einzelgruppen.*

*In einer Verpackungseinheit / Gurt ist immer nur eine Helligkeitsgruppe enthalten.*

*Die technologiebedingte Helligkeits-Streuung der heutigen LED-Herstellprozesse über einen längeren Fertigungszeitraum (Halbleitermaterial - Chipherstellung - Montageprozess) erlaubt keine Zusage einer einzelnen Helligkeitsgruppe. Daher müssen mindestens zwei Helligkeitsgruppen vorgesehen werden!*

*Note: The standard shipping format for serial types includes a lower or upper family group or at least two individual groups.*

*No packing unit / tape ever contains more than one luminous intensity group.*

*Luminosity variations caused by the technology used in current LED manufacturing processes over a protracted manufacturing period (semiconductor material - chip fabrication - assembly process) mean that it is not possible to assign LEDs to a single luminous intensity group. For this reason at least two luminous intensity groups must be provided!*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 55 ... + 100	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 55 ... + 100	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 100	°C
Durchlassstrom Forward current	$I_F$	20	mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	0.2	A
Sperrspannung Reverse voltage	$V_R$	5	V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	90	mW
Wärmewiderstand <sup>1)</sup> Thermal resistance Sperrschicht/Umgebung Junction/air Sperrschicht/Löt­pad Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ ) Minimale Beinchenlänge Minimum lead length	$R_{th JA}$  $R_{th JS}$	500  280	K/W  K/W

<sup>1)</sup>  $R_{th}$  erhöht sich um 13 K/W pro mm Beinchenlänge.  
Each additional 1 mm of lead length increases  $R_{th}$  by 13 K/W.

Kennwerte ( $T_A = 25\text{ °C}$ )

## Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Wellenlänge des emittierten Lichtes Wavelength at peak emission $I_F = 10\text{ mA}$	(typ.) $\lambda_{\text{peak}}$	428	nm
Dominantwellenlänge Dominant wavelength $I_F = 10\text{ mA}$	(typ.) $\lambda_{\text{dom}}$	465	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 10\text{ mA}$	(typ.) $\Delta\lambda$	60	nm
Durchlassspannung <sup>1)</sup> Forward voltage <sup>1)</sup> $I_F = 10\text{ mA}$	(typ.) $V_F$ (max.) $V_F$	3.5 4.1	V V
Sperrstrom Reverse current $V_R = 5\text{ V}$	(typ.) $I_R$ (max.) $I_R$	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_{\lambda_{\text{peak}}}$	0.004	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_{\lambda_{\text{dom}}}$	0.03	nm/K
Temperaturkoeffizient von $V_F$ Temperature coefficient of $V_F$ $I_F = 10\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_V$	- 3.1	mV/K
Optischer Wirkungsgrad Optical efficiency $I_F = 10\text{ mA}$	(typ.) $\eta_{\text{opt}}$	1	lm/W

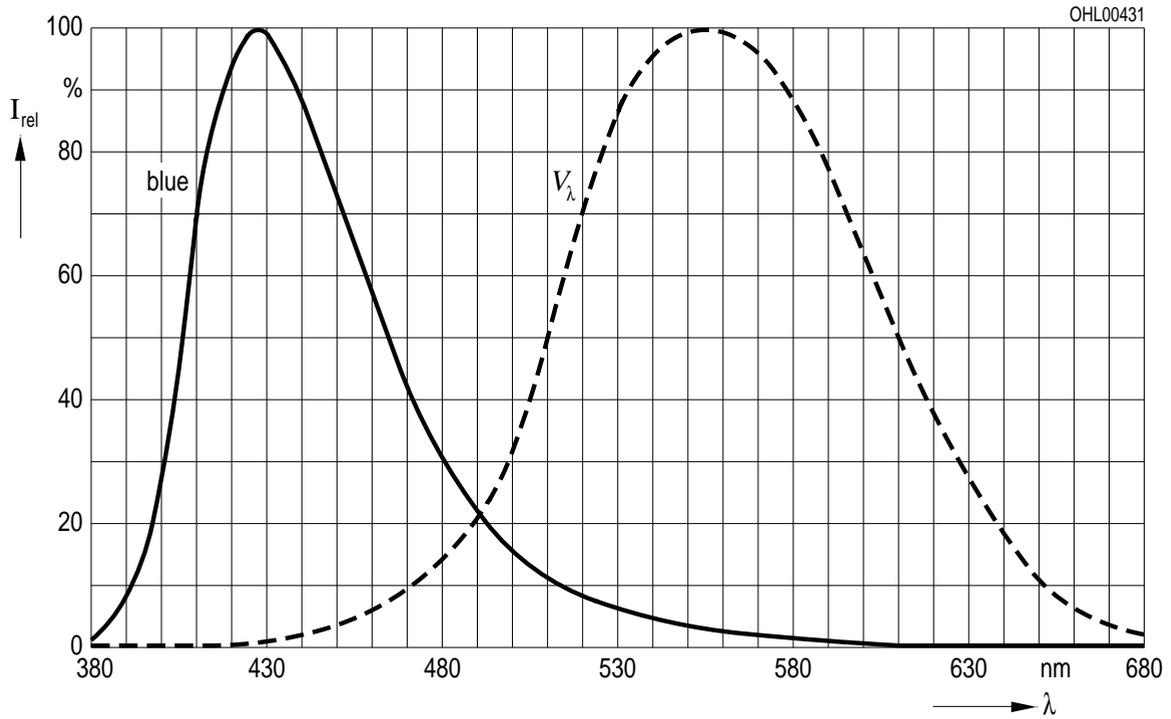
<sup>1)</sup> Spannungswerte werden mit einer Stromeinprägendauer von 1 ms und einer Genauigkeit von  $\pm 0,1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 10\text{ mA}$

**Relative Spectral Emission**

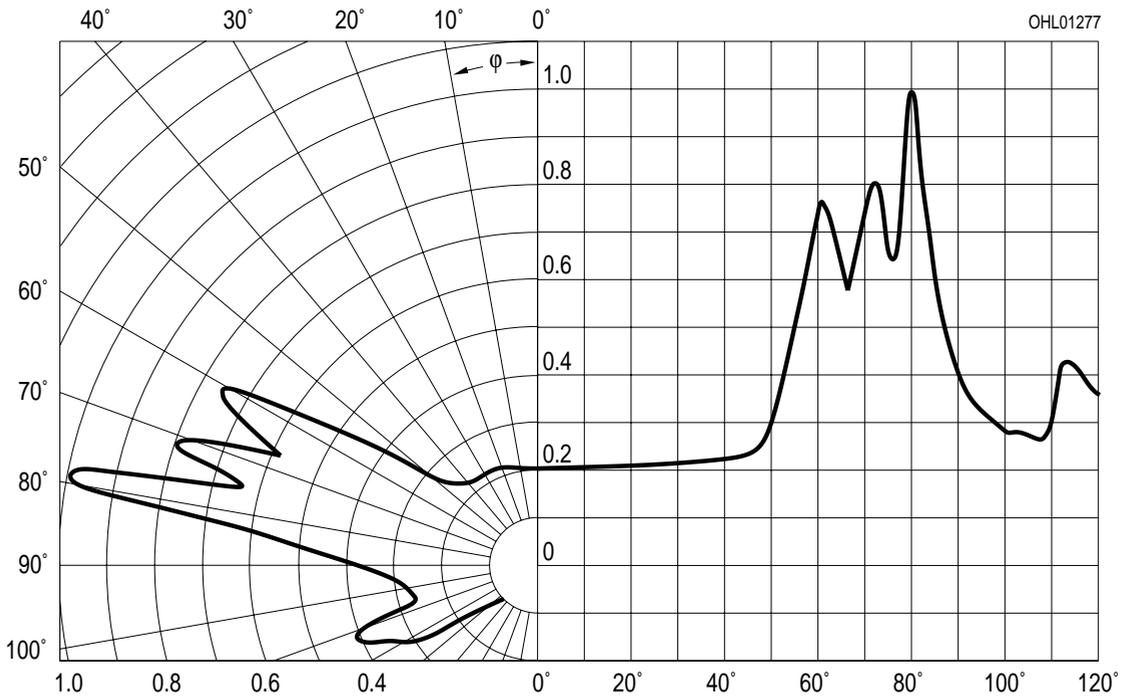
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



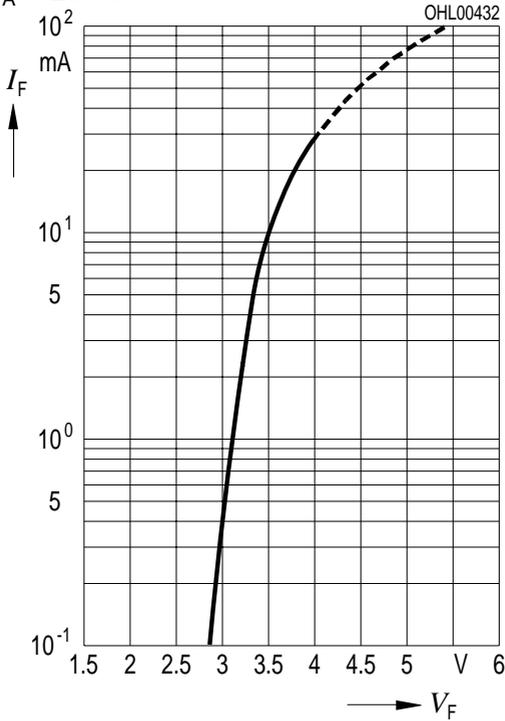
Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

**Radiation Characteristic**



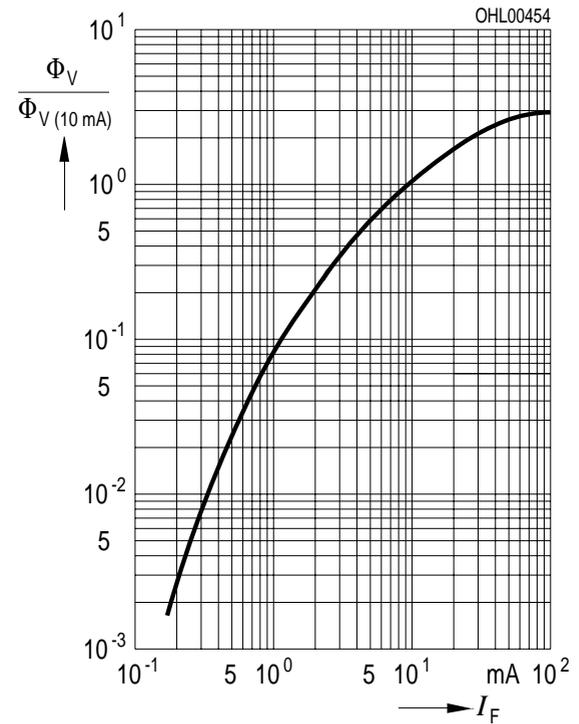
**Durchlassstrom  $I_F = f(V_F)$   
Forward Current**

$T_A = 25\text{ °C}$

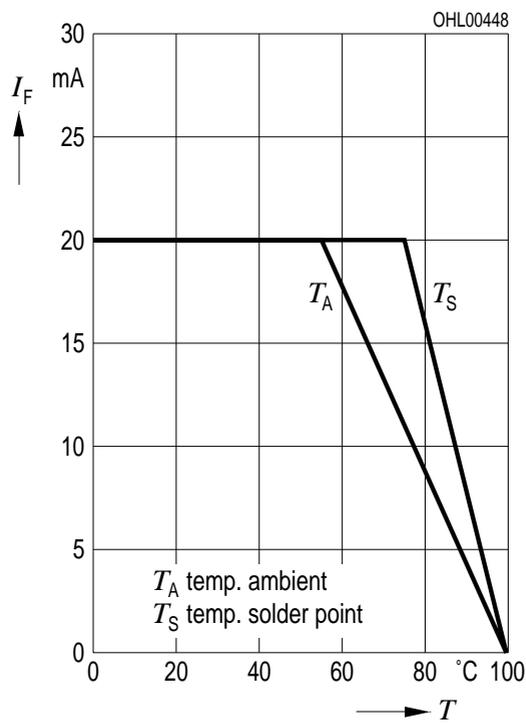


**Relativer Lichtstrom  $\Phi_V / \Phi_{V(10\text{ mA})} = f(I_F)$   
Relative Luminous Flux**

$T_A = 25\text{ °C}$

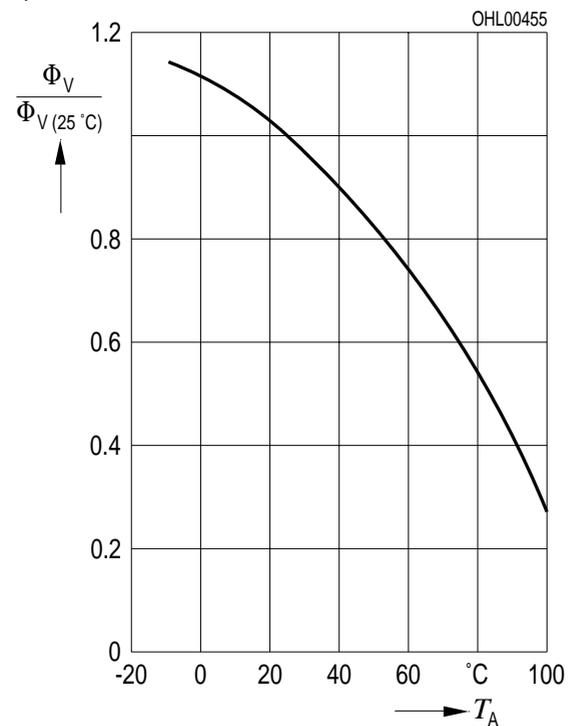


**Maximal zulässiger Durchlassstrom  $I_F = f(T)$   
Max. Permissible Forward Current**

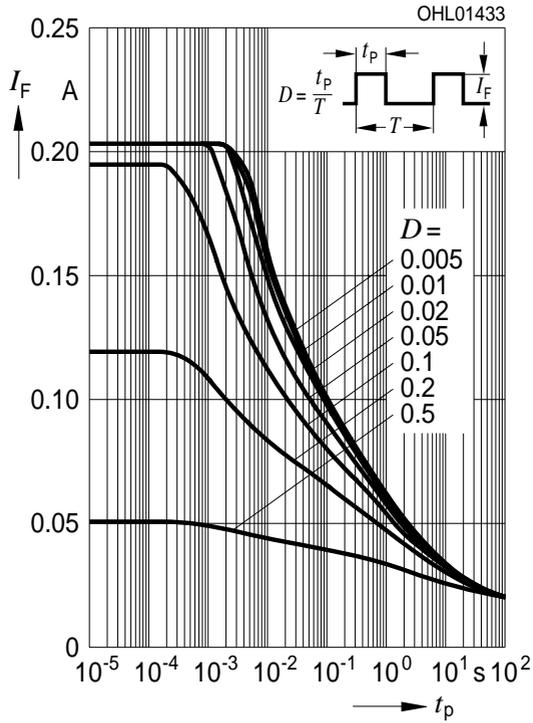


**Relativer Lichtstrom  $\Phi_V / \Phi_{V(25\text{ °C})} = f(T_A)$   
Relative Luminous Flux**

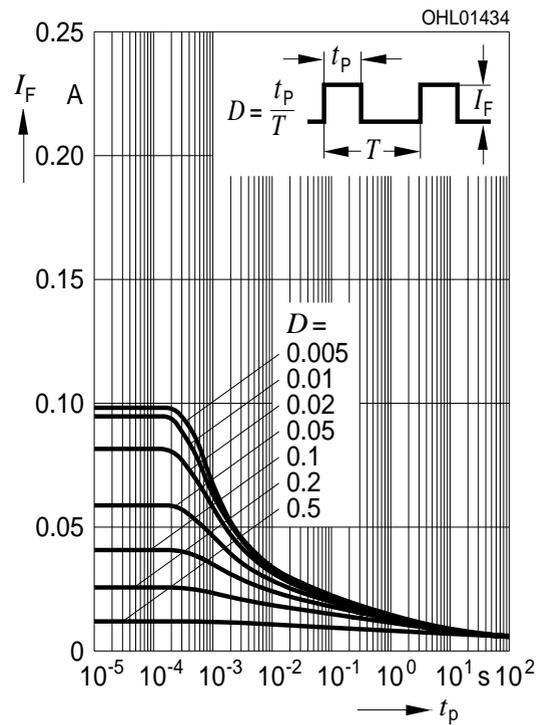
$I_F = 10\text{ mA}$



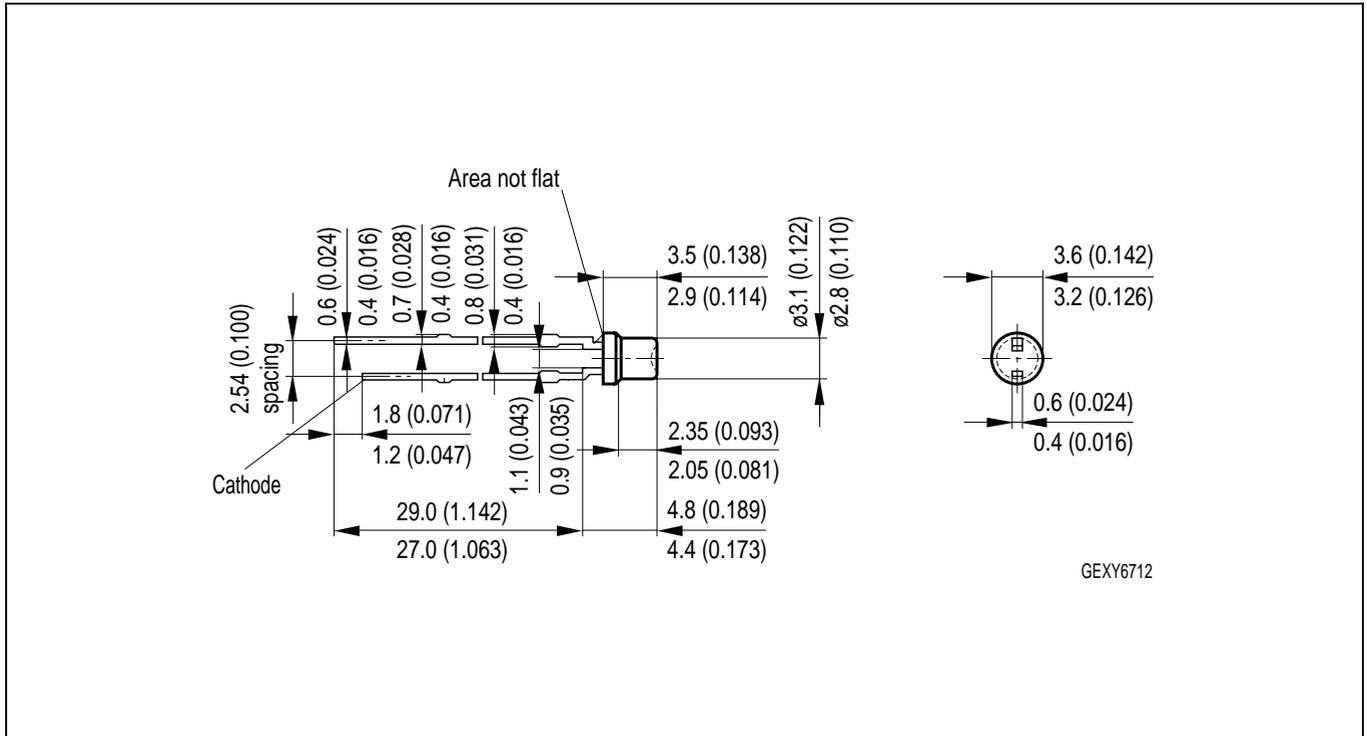
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$



**Maßzeichnung**  
**Package Outlines**

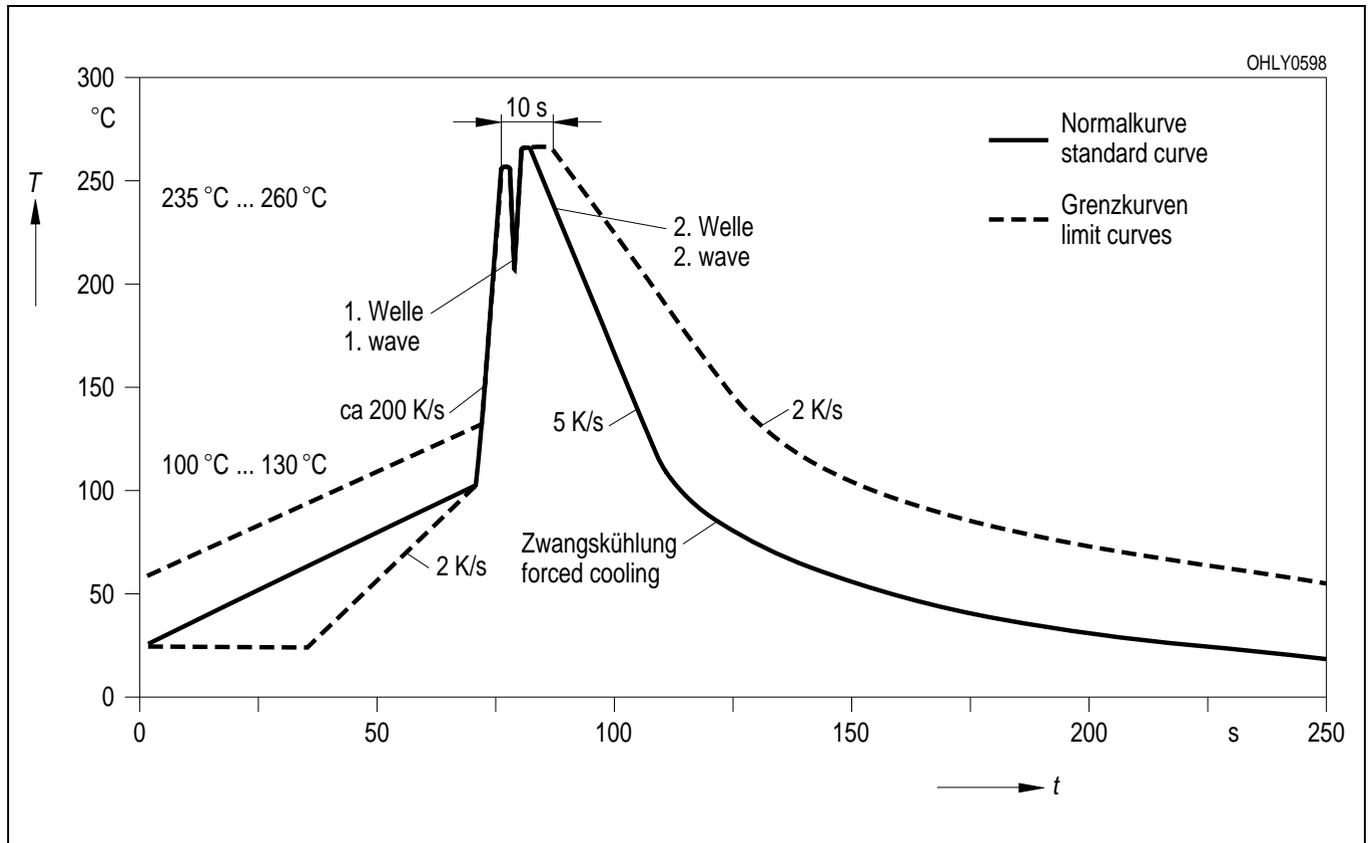


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

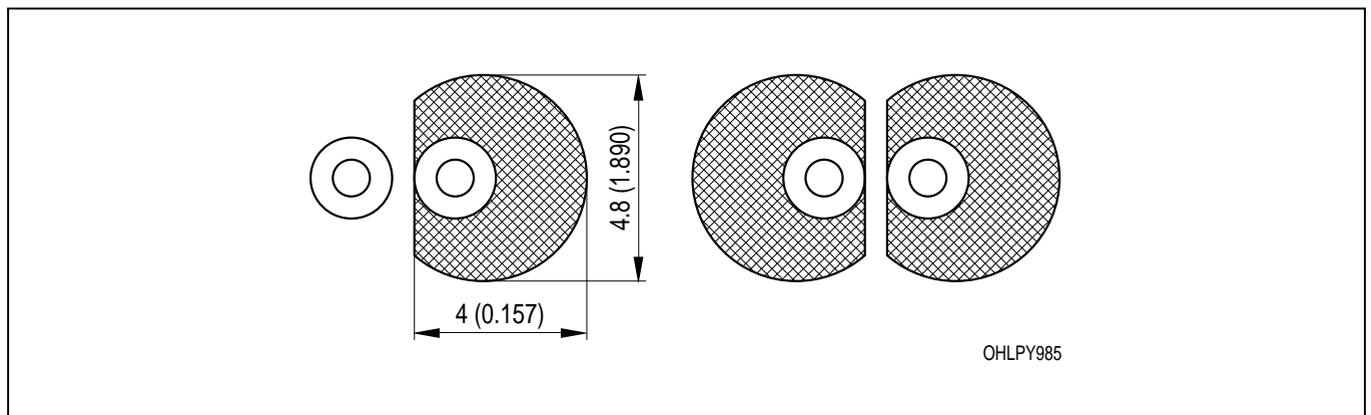
**Kathodenkennung:** kürzerer Lötspieß  
**Cathode mark:** short solder lead  
**Gewicht / Approx. weight:** 160 mg

**Lötbedingungen**  
**Soldering Conditions**

**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpad design** Wellenlöten (TTW)  
**Recommended Solder Pad** TTW Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Revision History: 2002-02-08**

Previous Version: 2001-02-08

Page	Subjects (major changes since last revision)
3	thermal resistance (footnote)

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